

SMT750-25

Infrared TOP IR LED with lens

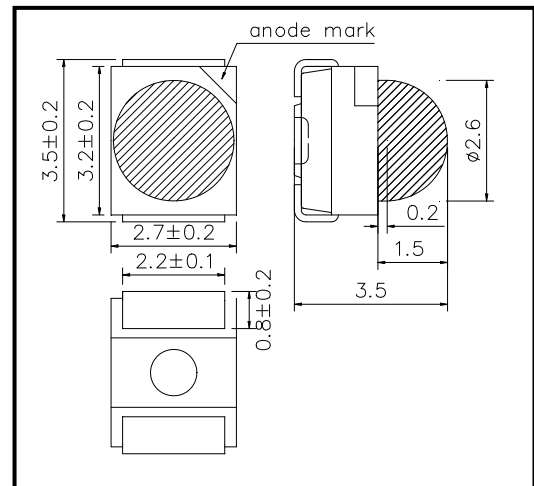
SMT750-25 consists of an AlGaAs LED mounted on the lead frame as TOP LED package with epoxy resin lens and is 24mW/sr typical.

It emits a spectral band of radiation at 750nm.

◆ Outer dimension (Unit:mm)

◆ Specifications

1) Product Name	TOP IR LED with lens
2) Type No.	SMT750-25
3) Chip	
(1) Chip Material	AlGaAs
(2) Peak Wavelength	750nm typ.
4) Package	
(1) Lead Frame Die	Silver Plated
(2) Package Resin	PPA Resin
(3) Lens	Epoxy Resin
(4) Diameter	Φ2.6mm



◆ Absolute Maximum Rating

Item	Symbol	Maximum Rated Value	Unit	Ambient Temperature
Power Dissipation	P _D	190	mW	T _a =25°C
Forward Current	I _F	100	mA	T _a =25°C
Pulse Forward Current	I _{FP}	500	mA	T _a =25°C
Reverse Voltage	V _R	5	V	T _a =25°C
Operating Temperature	T _{OPR}	-20 ~ +80	°C	
Storage Temperature	T _{STG}	-30 ~ +80	°C	
Soldering Temperature	T _{SOL}	250	°C	

‡Pulse Forward Current condition: Duty=1% and Pulse Width=10us.

‡Soldering condition: Soldering condition must be completed within 5 seconds at 250°C

◆ Electro-Optical Characteristics [T_a=25°C]

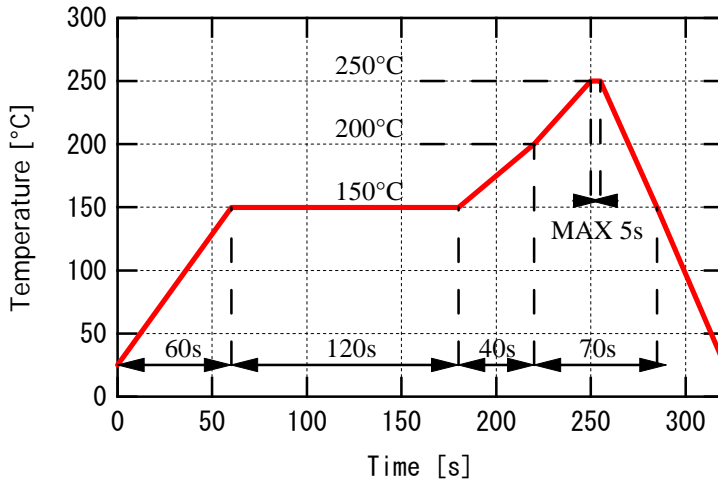
Item	Symbol	Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V _F	I _F =50mA		1.85	2.00	V
Reverse Current	I _R	V _R =5V			10	uA
Total Radiated Power	P _O	I _F =50mA	12.0	20.0		mW
Radiant Intensity	I _E	I _F =50mA	15.0	24.0		mW/sr
Peak Wavelength	λ _P	I _F =50mA	735	750	765	nm
Half Width	Δλ	I _F =50mA		35		nm
Viewing Half Angle	θ _{1/2}	I _F =50mA		±20		deg.
Rise Time	t _r	I _F =50mA		80		ns
Fall Time	t _f	I _F =50mA		80		ns

‡Total Radiated Power is measured by Photodyne #500

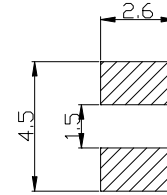
‡Radiant Intensity is measured by Tektronix J-6512.

◆ SMD Application

Recommended reflow soldering profile



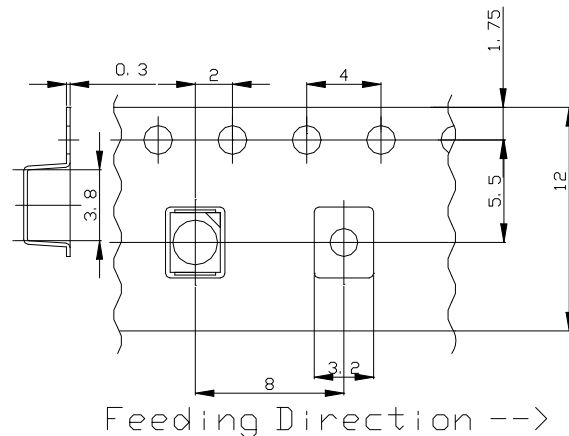
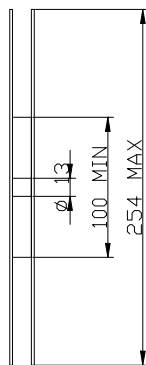
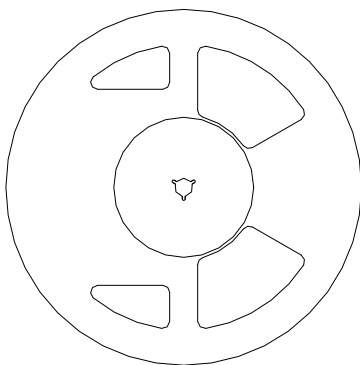
Recommended Land Layout (Unit: mm)



Don't put stress on SMD and a circuit board after soldering.

◆ SMD Packing

Tape and Reel Dimensions (Unit: mm)



Feeding Direction -->

◆ Wrapping

Moisture barrier bag aluminum laminated film with a desiccant to keep out the moisture absorption during the transportation and storage.

SMD LED STORAGE AND HANDLING PRECAUTIONS

< Storage Conditions before Opening a Moisture-Barrier Aluminum Bag >

- Before opening a moisture-barrier aluminum bag, please store it at <30°C, <60%RH. Please note that the maximum shelf life is 12 months under these conditions.

< Storage Conditions after Opening a Moisture-Barrier Aluminum Bag >

- After opening a moisture-barrier aluminum bag, store the aluminum bag and silica gel in a desiccator.
- After opening the bag, please solder the LEDs within 72 hours in a room with 5 - 30°C, <50%RH.
- Please put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.

< Notes about Re-sealing a Moisture-Barrier Aluminum Bag >

- When vacuum-sealing an opened aluminum bag, if you find the moisture-indicator of the silica gel has changed to pink from blue (indicating a relative humidity of 30 % or more), please do not use the unused LEDs, the aluminum bag, or the silica gel.

< Notes about Opening a Re-sealed Moisture-Barrier Aluminum Bag >

- When opening a vacuumed and re-sealed aluminum bag in order to use the remaining LEDs stored in the bag, if you find that the moisture-indicator of the silica has changed to pink, please do not use the LEDs.

※The 72-hour- long floor life does not include the time while LEDs are stored in the moisture-barrier aluminum bag.
However, we strongly recommend to solder the LEDs as soon as possible after opening the aluminum bag.